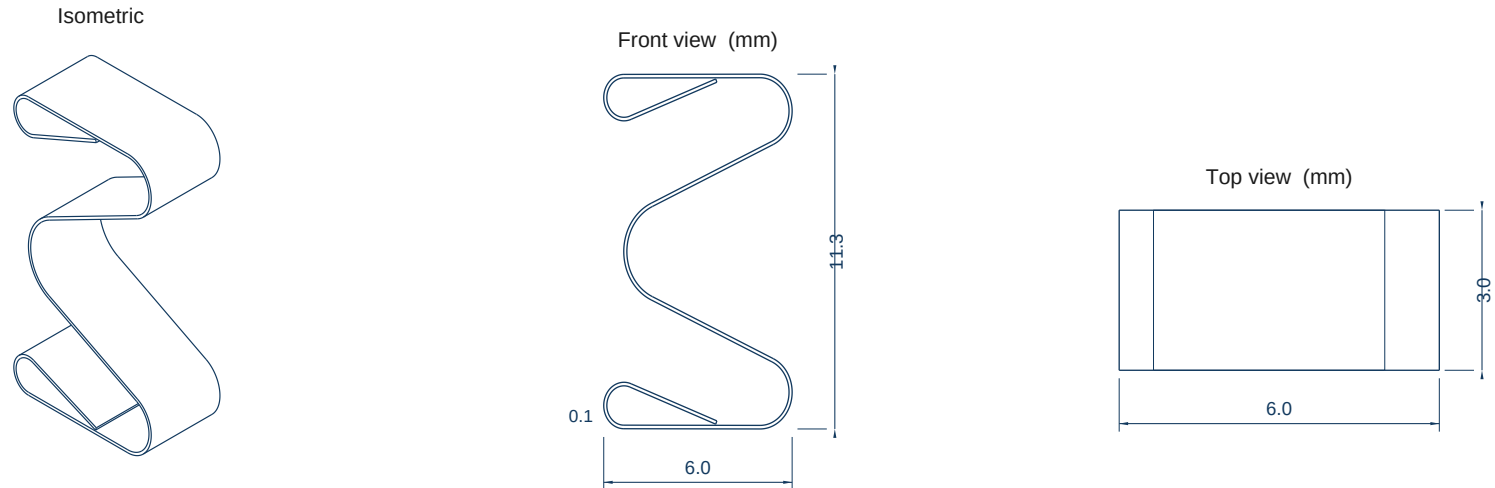




Type 3-01 B301-30060113

SMD EMI Spring Contact | Beryllium Copper | Units: mm



MECHANICAL	VALUE
Thickness	0.10 mm
Width	3.0 mm +/- 0.2
Length	6.0 mm +/- 0.2
Height	11.3 mm +/- 0.2
Form	Z-serpentine: 2 folded hems, 3 curls, mirror-symmetric
Profile source	B3-30060100 solid, height-scaled x1.136 - see note
Material / plating	BeCu, Gold-plated (G)
Volume / mass	12.151 mm ³ 101.5 mg (BeCu)
File format	STEP AP214

PRODUCT DATA	VALUE
Mfr P/N	B301-30060113G-SY (Au)
Brand	Seyunda
Description	SMD EMI Contact 6.0x3.0x11.3mm Au
Packaging	Tape & Reel (TR)
Category	Connectors, Interconnects
Sub-category	Contacts, Spring Loaded (Pogo Pins), and Pressure
Lifecycle / origin	Active / Taiwan, Republic of China
RoHS / REACH	RoHS3 Compliant / REACH Unaffected
ECCN / ESD	EAR99 / Static sensitive: Yes
Datasheet	seyunda.com/datasheet/Seyunda-SMD-Spring-Contacts-Datasheet.pdf
Product page	seyunda.com/type-3-01.html